



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Penica, John R	Contact Title	Sr Mgr Engineering, IND Central Eng		
Company Unique ID	TE Connectivity	Response Date	2018-03-23	Contact Email	jrpenica@te.com				
Contact Phone Number	+1-717-592-3266								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	104069-3	Amount	4.51467346	Version	-	Identity			
Manufacturer Item Name	80 SYSTEM 50 HDR DRRA SHRD	Weight Uom	g	Mfr Site		Authority			
Date		UOM	Each						
EURoHS-0508	Product(s) does not meet EU RoHS requirements and is not under exemptions								
ChinaRoHS-0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Sub-Item	1	SYSTEM 50 POST PLTD 30 DPLX				40.0	0.01239179	g	
Material	2	Nickel Plate				40.0	4.413E-6	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	40.0	1.0E-8	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	40.0	1.0E-8	g	
Substance	3	Nickel	Nickel	7440-02-0	99.7	40.0	4.399761E-6	g	
Material	2	Gold Plate				40.0	1.032E-5	g	
Substance	3	Gold	Supplier	7440-57-5	99.7	40.0	1.028904E-5	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	40.0	3.096E-8	g	
Material	2	Brass				40.0	0.01222219	g	
Substance	3	Tin	Supplier	7440-31-5	0.1	40.0	1.222219E-5	g	
Substance	3	Copper	Supplier	7440-50-8	64.0	40.0	0.0078222	g	
Substance	3	Iron	Supplier	7439-89-6	0.05	40.0	6.111093E-6	g	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	40.0	1.222219E-7	g	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	40.0	1.222219E-6	g	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	40.0	1.222219E-5	g	
Substance	3	Manganese	Supplier	7439-96-5	0.1	40.0	1.222219E-5	g	
Substance	3	Zinc	Supplier	7440-66-6	35.2085	40.0	0.00430325	g	
Substance	3	Antimony	Supplier	7440-36-0	0.01	40.0	1.222219E-6	g	
Substance	3	Chromium	Supplier	7440-47-3	0.01	40.0	1.222219E-6	g	
Substance	3	Aluminum	Supplier	7429-90-5	0.05	40.0	6.111093E-6	g	
Substance	3	Nickel	Nickel	7440-02-0	0.3	40.0	3.666656E-5	g	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	40.0	1.222219E-6	g	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	40.0	6.111093E-8	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	40.0	6.111093E-6	g	
Material	2	Gold Flash				40.0	5.87E-6	g	

Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	40.0	1.761E-8	g	
Substance	3	Gold	Supplier	7440-57-5	99.7	40.0	5.85239E-6	g	
Material	2	Tin-Lead Plate				40.0	1.49E-4	g	
Substance	3	Tin	Supplier	7440-31-5	86.5	40.0	1.2888E-4	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.5	40.0	7.45E-7	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	13.0	40.0	1.937E-5	g	
Sub-Item	1	SYSTEM 50 POST PLTD 30 DPLX				40.0	0.01400001	g	
Material	2	Nickel Plate				40.0	6.619E-6	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	40.0	1.3238E-8	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	40.0	1.0E-8	g	
Substance	3	Nickel	Nickel	7440-02-0	99.7	40.0	6.599143E-6	g	
Material	2	Gold Plate				40.0	1.032E-5	g	
Substance	3	Gold	Supplier	7440-57-5	99.7	40.0	1.028904E-5	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	40.0	3.096E-8	g	
Material	2	Brass				40.0	0.0138282	g	
Substance	3	Tin	Supplier	7440-31-5	0.1	40.0	1.38282E-5	g	
Substance	3	Copper	Supplier	7440-50-8	64.0	40.0	0.00885005	g	
Substance	3	Iron	Supplier	7439-89-6	0.05	40.0	6.9141E-6	g	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	40.0	1.38282E-7	g	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	40.0	1.38282E-6	g	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	40.0	1.38282E-5	g	
Substance	3	Manganese	Supplier	7439-96-5	0.1	40.0	1.38282E-5	g	
Substance	3	Zinc	Supplier	7440-66-6	35.2085	40.0	0.0048687	g	
Substance	3	Antimony	Supplier	7440-36-0	0.01	40.0	1.38282E-6	g	
Substance	3	Chromium	Supplier	7440-47-3	0.01	40.0	1.38282E-6	g	
Substance	3	Aluminum	Supplier	7429-90-5	0.05	40.0	6.9141E-6	g	
Substance	3	Nickel	Nickel	7440-02-0	0.3	40.0	4.14846E-5	g	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	40.0	1.38282E-6	g	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	40.0	6.9141E-8	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	40.0	6.9141E-6	g	
Material	2	Gold Flash				40.0	5.87E-6	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	40.0	1.761E-8	g	
Substance	3	Gold	Supplier	7440-57-5	99.7	40.0	5.85239E-6	g	
Material	2	Tin-Lead Plate				40.0	1.49E-4	g	
Substance	3	Tin	Supplier	7440-31-5	86.5	40.0	1.2888E-4	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.5	40.0	7.45E-7	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	13.0	40.0	1.937E-5	g	
Sub-Item	1	80 SYSTEM 50 HDR HSG DR LATCH				1.0	3.36	g	
Material	2	LCP-GF35				1.0	3.36	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	2.0	1.0	0.0672	g	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	34.3	1.0	1.15248	g	
Substance	3	1,3-Benzenedicarboxylic acid, polymer with 1,4-benzenedicarboxylic acid, [1,1-biphenyl]-4,4-diol and 4-hydroxybenzoic acid	Supplier	60088-52-0	62.7	1.0	2.10672	g	

Substance	3	Carbon black	Supplier	1333-86-4	1.0	1.0	0.0336	g	
Sub-Item	1	SYSTEM 50 SDR CLIP 150 SN-PB				3.0	0.0330005	g	
Material	2	Nickel Plate				3.0	9.965E-4	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2- 1212	0.2	3.0	1.993E-6	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	3.0	9.965E-7	g	
Substance	3	Nickel	Nickel	7440-02-0	99.7	3.0	9.9351E-4	g	
Material	2	Phos Bronze				3.0	0.029744	g	
Substance	3	Copper	Supplier	7440-50-8	94.6985	3.0	0.02816712	g	
Substance	3	Manganese	Supplier	7439-96-5	0.02	3.0	5.9488E-6	g	
Substance	3	Chromium	Supplier	7440-47-3	0.01	3.0	2.9744E-6	g	
Substance	3	Tin	Supplier	7440-31-5	4.5	3.0	0.00133848	g	
Substance	3	Arsenic	Supplier	7440-38-2	0.0050	3.0	1.4872E-6	g	
Substance	3	Iron	Supplier	7439-89-6	0.1	3.0	2.9744E-5	g	
Substance	3	Antimony	Supplier	7440-36-0	0.01	3.0	2.9744E-6	g	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	3.0	2.9744E-7	g	
Substance	3	Zinc	Supplier	7440-66-6	0.3	3.0	8.9232E-5	g	
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	3.0	2.9744E-5	g	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	3.0	2.9744E-5	g	
Substance	3	Cadmium	Cadmium/Cad mium Compounds	7440-43-9	0.0050	3.0	1.4872E-6	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	3.0	1.4872E-5	g	
Substance	3	Nickel	Nickel	7440-02-0	0.1	3.0	2.9744E-5	g	
Substance	3	Mercury	Mercury/Mercu ry Compounds	7439-97-6	5.0E-4	3.0	1.4872E-7	g	
Material	2	Tin-Lead Plate				3.0	0.00226	g	
Substance	3	Tin	Supplier	7440-31-5	86.5	3.0	0.0019549	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2- 1212	0.5	3.0	1.13E-5	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	13.0	3.0	2.938E-4	g	